



Content of Press Kit



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REN2314

Renesas Expands RA MCU Family with Two New Entry-Line Groups Offering Optimal Combination of Performance, Features and Value



REN2313

Renesas to Demonstrate First Al Implementations on the Arm Cortex-M85 Processor Featuring Helium Technology at Embedded World



REN2310

Renesas Delivers 10 New Winning Combinations That Include Both Automotive and Non-Automotive Products



REN2308

Renesas Unveils Quick-Connect Studio: Industry's First-Ever Cloud-based System Development Tool to Dynamically Create IoT Software



REN2307

Renesas Collaborates with AMD to Demo Full RF and Digital Front-End Design for 5G Active Antenna Systems



REN2304

Renesas Introduces New Gate Driver IC for IGBTs and SiC MOSFETs Driving EV inverters



REN2303

Renesas' New Automotive Intelligent Power Device Enables Safe and Flexible Power Distribution in Next-Generation E/E Architectures



REN2302

Renesas Introduces Low-Power RL78/G15 MCU with the Smallest 8-pin Package Option Available within the RL78 Family



REN2301

Renesas Announces Its First Wi-Fi Development Kit with Support for New Matter Protocol



REN2255

Renesas and Fixstars to Jointly Develop Tools Suite that Optimizes AD and ADAS AI Software for R-Car SoCs

